



For IEC use only

3/553/INF

1999-09

INTERNATIONAL ELECTROTECHNICAL COMMISSION

Technical Committee No. 3 Documentation and graphical symbols

Meeting of the Validation Team VT IEC 60617 in Kyoto

Following the circulation of the document 3/537/AC the nominations to the Validation Team for the maintenance of IEC 60617 has been received and the setting up of this team may be carried out as it states in the Annex. At the moment it shall be considered as provisional one, before a database procedure for the maintenance of IEC 60617 (see document 3/539B/INF) will be approved by the Committee of Action.

NOTE - This should also be considered as the initial membership of the Validation Team. Since the Validation Team is intended to represent all the National Committees taking part in the work (P-members), National Committees which have not yet appointed any delegate (with deputy) are continuously invited to do so.

In order to proceed immediately with the work, the first informal meeting of the Validation Team is to be held in Kyoto in the frame of the General Meeting of the IEC.

The meeting will take place on 26th and 27th October 1999, starting at 9:00 a.m. and will replace the meeting of the Maintenance Team MT 60617 originally scheduled in the official programme for Kyoto (see also document 35B/AC). There will be no meeting of the Maintenance Team MT 60617 in Kyoto since this team does not exist at the time being.

The main purpose of the meeting of the Validation Team is to discuss practical application of the database procedure according to the document 3/539B/INF, a further development of Task II of the former SC 3A/WG 1 and a splitting of work. A detailed programme will be circulated later.

This document is sent to the National Committees for information. The members of the Validation Team according to the Annex and the delegates which have been already registered to the MT 60617 in Kyoto will be instructed separately by the Assistant Secretary of TC 3.

A. Fornalski,
Assistant Secretary to TC 3

ANNEX

COMMISSION ELECTROTECHNIQUE INTERNATIONALE

COMITE D'ETUDES N° 3 : Documentation et symboles graphiques

Composition provisoire du Groupe de Validation de CEI 60617

A la suite de la diffusion du document
3/537/AC, le GV peut être formé comme suit:

GV: IEC 60617

Tâche :

Le Group de validation a la tâche suivante,
comme définie dans un document 3/537/AC:

Evaluation des propositions: des membres
des Comités nationaux qui ont été nommés
au group de validation atteindront le
consensus dans l'acceptation de proposition
pour le travail,

Sélection de procédure: le group de
validation décide si la procédure simplifiée ou la
compréhensive doit être suivie pour le symbole
à évaluation,

Validation des symboles graphiques: le vote
au nom de son Comité national pour libération
de symbole graphique.

INTERNATIONAL ELECTROTECHNICAL COMMISSION

TECHNICAL COMMITTEE No. 3: Documentation and Graphical Symbols

Provisional membership of the Validation Team for IEC 60617

Following the circulation of Document
3/537/AC, the Validation Team is to be set up
as follows:

VT IEC 60617

Task :

The validation team has the following tasks, as
further defined in document 3/537/AC:

Evaluation of proposals: members of the
National Committees that are part of the
validation team reach consensus on the
acceptance of a proposal for work;

Selection of procedure: the validation
Team decides whether the simplified or the
comprehensive procedure should be
followed for a symbol;

Validation of graphical symbols: voting
on behalf of their National Committees for
release of a graphical symbol.

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